Supporting Information

Preparation of solid silver nanoparticles for inkjet printed flexible electronics with high conductivity

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Figure S1. Optical microscope image of print-head orifice.

Figure S2. (a)–(c) SEM images and (d) sheet resistance of printed silver patterns treated with different amounts of PDAC solution at room temperature.
Figure S3. Different silver conductive 2D-patterns printed on various flexible substrates.
Figure S4. Demonstration of working LED device in a bend position.